



Fast Recovery Rectifier

Features

- Fast switching speed for high efficiency
- Low reverse leakage
- High forward surge current capacity
- High temperature soldering guaranteed:
260°C/10 seconds, 0.375" (9.5mm) lead length
- RoHS and REACH Compliance

Mechanical Data

Case:	Transfer molded plastic
Polarity	Color band denots cathode end
Lead:	Plated axial lead, solderable per MIL-STD-202E method 208C
Mounting position:	Any
Weight:	0.014 ounce, 0.39 gram

Maximum Ratings ($T_{Ambient}=25^{\circ}C$ unless noted otherwise)

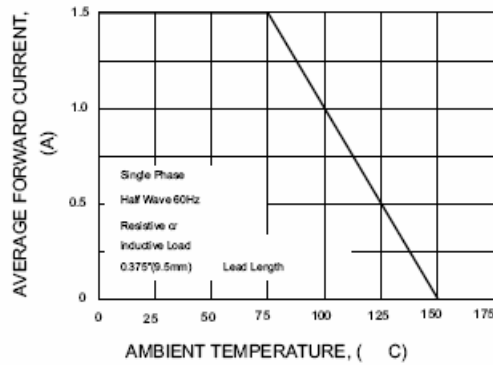
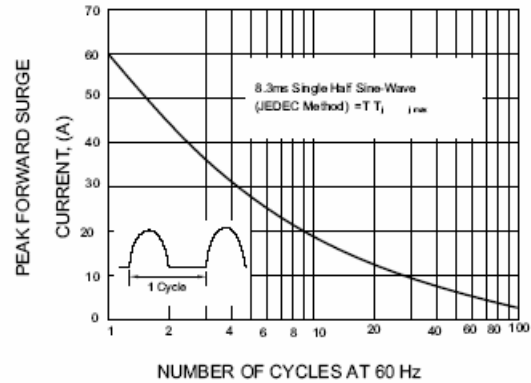
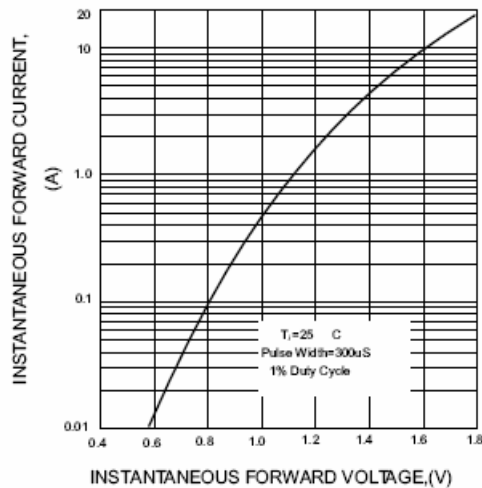
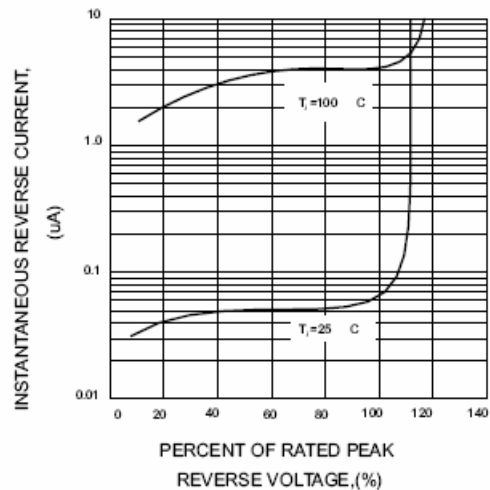
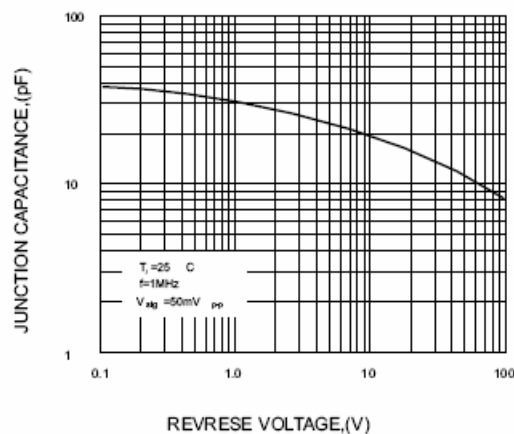
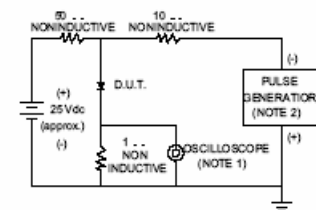
Symbol	Description	FR151	FR152	FR153	FR154	FR155	FR156	FR157	Unit	Conditions
VRRM	Max Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V	
VRMS	Max RMS Voltage	35	70	140	280	420	560	700	V	
VDC	Max DC Blocking Voltage	50	100	200	400	600	800	1000	V	
I(AV)	Max Average Forward Rectified Current	1.5							A	TC=75°C
IFSM	Peak Forward Surge Current	60							A	JEDEC method
TJ,TSTG	Operating and Storage Temperature Range	-65 to +150, -65 to +150							°C	
Rθ-JA	Typical Thermal Resistance	50							°C/W	Note 2

Electrical Characteristics ($T_{Ambient}=25^{\circ}C$ unless noted otherwise)

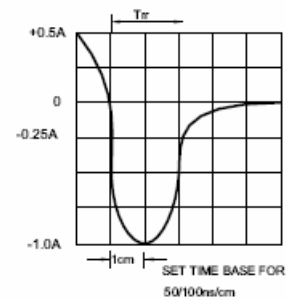
Symbol	Description	FR151	FR152	FR153	FR154	FR155	FR156	FR157	Unit	Conditions
VF	Max Instantaneous Forward Voltage	1.3							V	1.5A
IR	Max DC Reverse Current at Rated DC Blocking Voltage	5.0							μA	TA=25°C
		200							mA	TA=100°C
TRR	Maximum reverse recovery time	150		250			500		nS	Note 1
CJ	Typical Junction Capacitance	25							pF	Measured at 1.0MHz / 4.0V

Note:

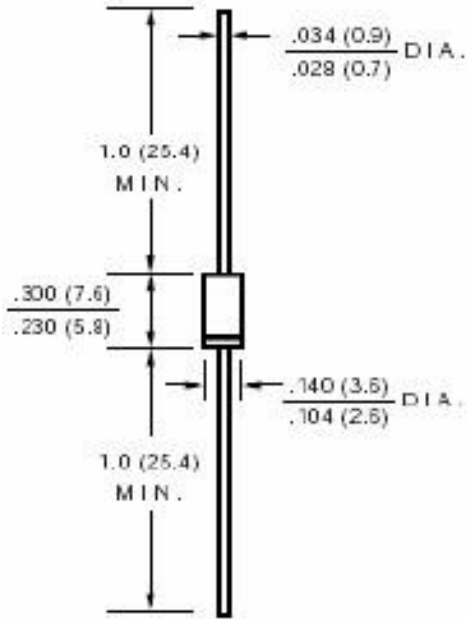
1. Reverse recovery test conditions: $I_F=0.5A$, $I_R=1.0A$, $I_{RR}=0.25A$
2. Thermal resistance from junction to ambient with 0.375" (9.5mm) lead length, PCB mounted

FR151 ~ FR157
RATINGS AND CHARACTERISTIC CURVES FR151 THRU FR157
FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

FIG.4-TYPICAL REVERSE CHARACTERISTICS

FIG.5-TYPICAL JUNCTION CAPACITANCE

FIG.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC


NOTES: 1. Rise Time = 7ns max. Input Impedance = 1 megaohm, 22pF
 2. Rise time = 10ns max. Source Impedance = 50 ohms



Dimensions in inches (mm)



DO-15

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